



DCR4420H65

Phase Control Thyristor

Replaces DS6118-3 DS6118-4 August 2021 (LN41119)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Bridge Rectifiers
- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
DCR4420H65* DCR4420H60 DCR4420H55	6500 6000 5500	Tvj = -40°C to 125°C, IDRM = IRRM = 600mA, VDRM, VRRM tp = 10ms VDSM & VRSM = VDRM & VRRM + 100V respectively

Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR4420H65

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

\mathbf{V}_{DRM}	6500V
IT(AV)	4350A
Ітѕм	64600A
dV/dt*	2000V/μs
dI/dt	500A/μs

^{*} Higher dV/dt selections are available on request

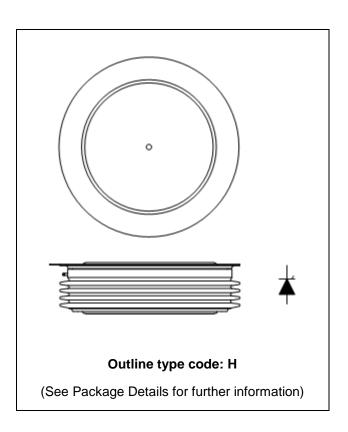


Fig. 1 Package outline

www.dynexsemi.com 1/10

^{*6200}V @ -40°C, 6500V @ 0°C



CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
İT(AV)	Mean on-state current	Half wave resistive load	4350	А
IT(RMS)	RMS value	-	6830	А
lτ	Continuous (direct) on-state current	-	6260	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, Tcase = 125°C	64.6	kA
l²t	I ² t for fusing	V _R = 0	20.9	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Condition	Min.	Max.	Units	
		Double side cooled	DC	-	4.3	°C/kW
Rth(j-c)	Rth(j-c) Thermal resistance - junction to case	Single side engled	Anode DC	-	8.0	°C/kW
		Single side cooled	Cathode DC	-	9.5	°C/kW
Da (. 1)	Thermal resistance - case to	Clamping force 135kN	Double side	-	0.9	°C/kW
Rth(c-h)	heatsink	(with mounting compound)	Single side	-	1.8	°C/kW
Tvj	Virtual junction temperature	Blocking VDRM / VRRM			125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			120	155	kN

www.dynexsemi.com 2/10



DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions			Max.	Units
IRRM/IDRM	Peak reverse and off-state current	At VRRM/VDRM, Tcase = 125°C	;	-	600	mA
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		1.75	2.00	٧
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C, g	ate open	-	2000	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 2x I _{T(AV)} Gate source 30V, 10Ω	Repetitive 50Hz	-	200	A/µs
ui/at	ivate of fise of off-state current	tr < 0.5µs, Tj = 125°C	Non-repetitive	-	500	A/µs
V	Threshold voltage - Low level	1000A to 5000A at Tcase = 125°C		-	1.19	٧
V T(TO)	Threshold voltage - High level	5000A to 8000A at Tcase = 125°C		-	1.29	٧
_	On-state slope resistance - low level	ate slope resistance - low level 1000A to 5000A at Tcase = 125°C		-	0.20	mΩ
ľτ	On-state slope resistance - High level	5000A to 8000A at Tcase = 1)A at Tcase = 125°C			mΩ
tgd	Delay time	$V_D = 67\% \ V_{DRM}, \ gate \ source \ 30V, \ 10\Omega$ $t_T = 0.5 \mu s, \ T_j = 25 ^{\circ} C$		-	3	μs
tq	Turn-off time	Iτ = 3000A, T _j = 125°C, V _R = 200V, dI/dt = 1A/μs, dV _{DR} /dt = 20V/μs linear		-	400	μs
Qs	Stored charge	Iτ = 3000A, T _j = 125°C, dI/dt = 1A/μs VR(peak) ~ 3900V, VRM ~ 2600V		2300	5000	μC
IRR	Reverse recovery current			37	52	А
lι	Latching current	T _j = 25°C, V _D = 5V		-	3	Α
Ін	Holding current	Tj = 25°C, Rg-к = ∞, Iтм = 50	0A, Ιτ = 5A	-	300	mA

www.dynexsemi.com 3/10



GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V GT	Gate trigger voltage	VDRM = 5V, Tcase = 25°C	1.5	٧
V GD	Gate non-trigger voltage	At 50% VDRM, Tcase = 125°C	0.4	V
Ідт	Gate trigger current	VDRM = 5V, Tcase = 25°C	350	mA
lgp	Gate non-trigger current	At 50% VDRM, Tcase = 125°C	10	mA

CURVES

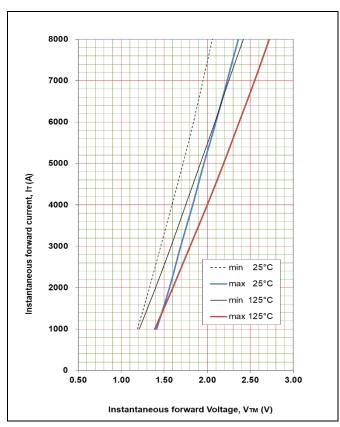


Fig. 2 Maximum & minimum on-state characteristics

VTM EQUATION

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$

Where A = 0.904719

B = 0.034296

C = 0.000157

D = 0.002862

These values are valid for T_j = 125°C for I_T 1000A to 8000A

www.dynexsemi.com 4/10



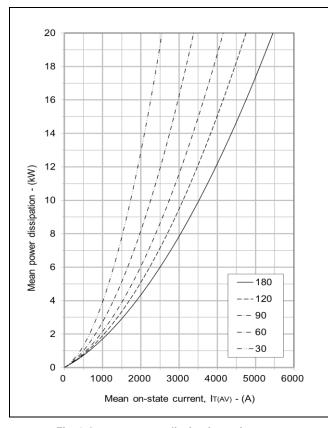


Fig. 3 On-state power dissipation - sine wave

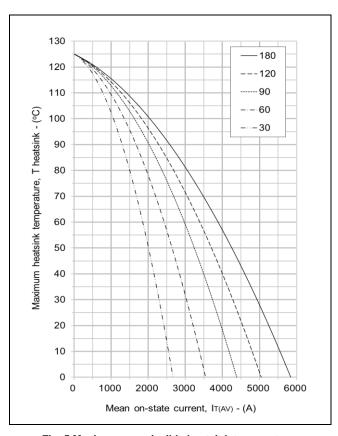


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

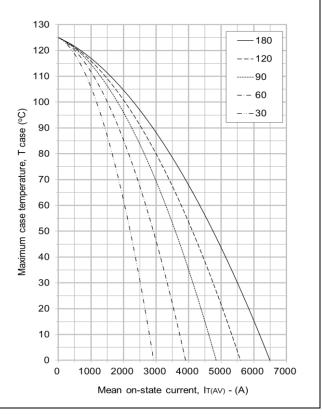


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

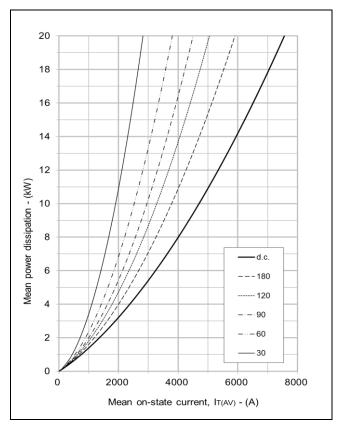


Fig. 6 On-state power dissipation - rectangular wave

www.dynexsemi.com 5/10



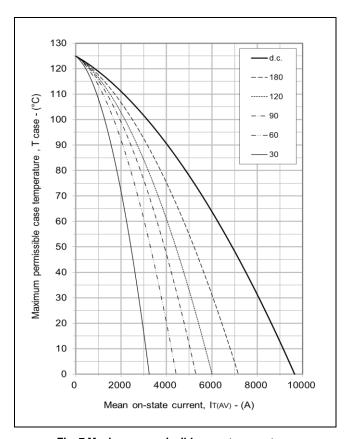
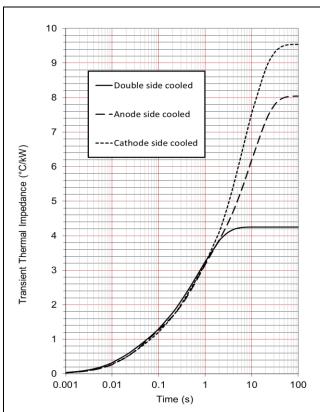


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



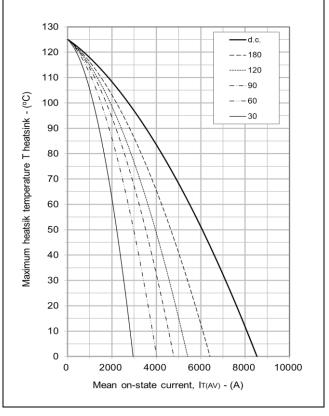


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side cooled	Ri(°C/kW)	1.248	0.833	0.606	1.568
Double side cooled	Ti(s)	0.670	0.146	0.020	1.287
Anode side cooled	Ri(°C/kW)	0.512	1.946	0.920	4.666
	Ti(s)	2.898	0.505	0.036	10.647
Cathode side	Ri(°C/kW)	2.417	1.537	0.626	4.959
cooled	Ti(s)	3.441	0.269	0.024	10.172

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{\text{th(j-c)}}$ Conduction

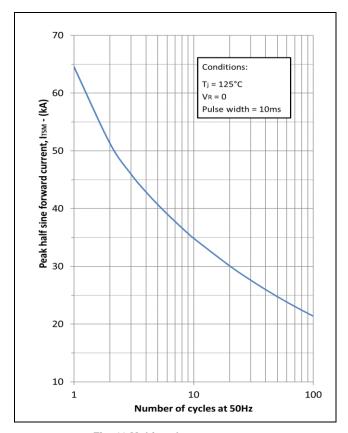
Tables show the increments of thermal resistance R $_{\text{th}(j-q)}$ when the device operates at conduction angles other than d.c.

	D	ouble side c	ooling	Anode Side Cooling			Cathode Sided Cooling		
		ΔZ_{th}	(z)		ΔZ _{th} (z)			ΔZ	th (Z)
	θ°	sine.	rect.	θ°	sine.	rect.	θ°	sine.	rect.
1	180	0.38	0.26	180	0.32	0.23	180	0.33	0.23
1	120	0.44	0.37	120	0.36	0.31	120	0.38	0.33
1	90	0.49	0.43	90	0.41	0.36	90	0.43	0.37
(60	0.54	0.49	60	0.45	0.40	60	0.47	0.43
	30	0.58	0.55	30	0.48	0.45	30	0.51	0.48
	15	0.60	0.58	15	0.49	0.48	15	0.52	0.51

Fig. 9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

www.dynexsemi.com 6/10





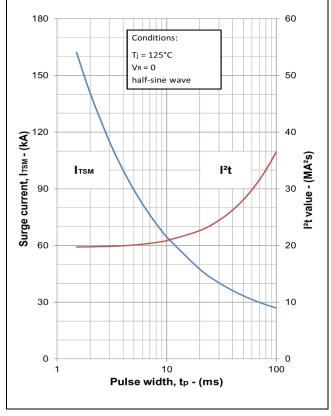


Fig. 10 Multi-cycle surge current

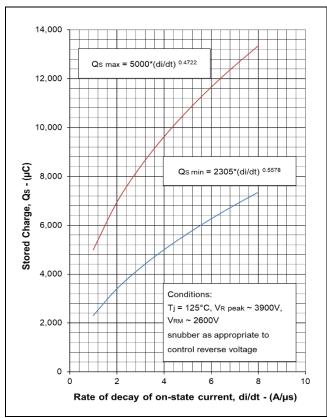


Fig. 12 Reverse recovery charge

Fig. 11 Single-cycle surge current

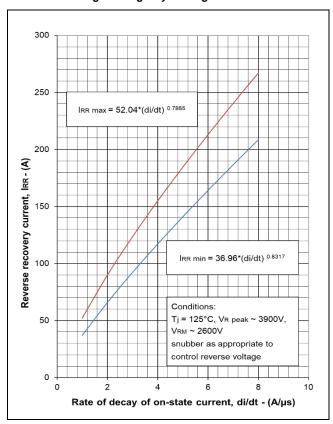


Fig. 13 Reverse recovery current

www.dynexsemi.com 7/10



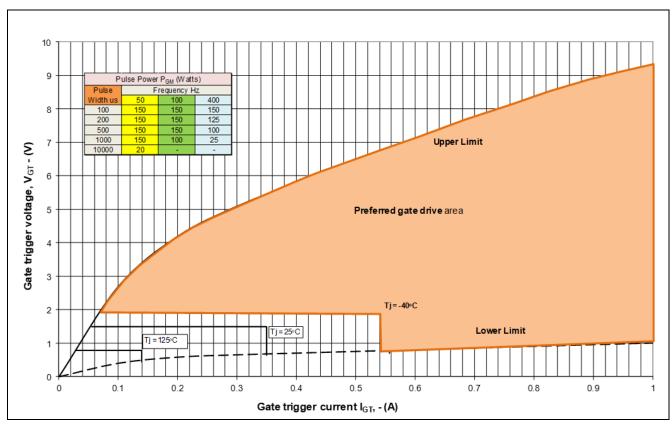


Fig. 14 Gate characteristics

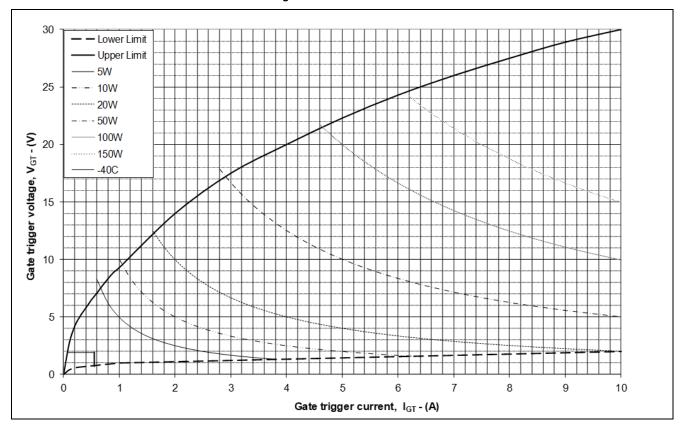


Fig. 15 Gate characteristics

www.dynexsemi.com 8/10

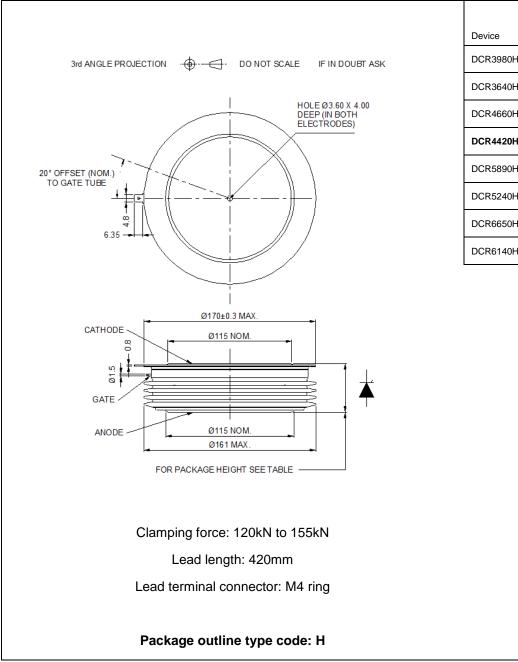


PACKAGE DETAILS

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE



Maximum	Minimum
Thickness	Thickness
(mm)	(mm)
35.7	35.1
35.7	35.1
35.4	34.7
35.4	34.7
35.1	34.5
35.1	34.5
35.0	34.3
35.0	34.3
	Thickness (mm) 35.7 35.7 35.4 35.4 35.1 35.1

Fig. 16 Package outline

www.dynexsemi.com 9/10



IMPORTANT INFORMATION:

This publication is provided for information only and not for resale.

The products and information in this publication are intended for use by appropriately trained technical personnel.

Due to the diversity of product applications, the information contained herein is provided as a general guide only and does not constitute any guarantee of suitability for use in a specific application. The user must evaluate the suitability of the product and the completeness of the product data for the application. The user is responsible for product selection and ensuring all safety and any warning requirements are met. Should additional product information be needed please contact Customer Service.

Although we have endeavoured to carefully compile the information in this publication it may contain inaccuracies or typographical errors. The information is provided without any warranty or guarantee of any kind.

This publication is an uncontrolled document and is subject to change without notice. When referring to it please ensure that it is the most up to date version and has not been superseded.

The products are not intended for use in applications where a failure or malfunction may cause loss of life, injury or damage to property. The user must ensure that appropriate safety precautions are taken to prevent or mitigate the consequences of a product failure or malfunction.

The products must not be touched when operating because there is a danger of electrocution or severe burning. Always use protective safety equipment such as appropriate shields for the product and wear safety glasses. Even when disconnected any electric charge remaining in the product must be discharged and allowed to cool before safe handling using protective gloves.

Extended exposure to conditions outside the product ratings may affect reliability leading to premature product failure. Use outside the product ratings is likely to cause permanent damage to the product. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture, a large current to flow or high voltage arcing, resulting in fire or explosion. Appropriate application design and safety precautions should always be followed to protect persons and property.

Product Status & Product Ordering:

We annotate datasheets in the top right hand corner of the front page, to indicate product status if it is not yet fully approved for production. The annotations are as follows:

Target Information: This is the most tentative form of information and represents a very preliminary specification.

No actual design work on the product has been started.

Provisional Information: Some initial development work has been performed. The datasheet represents a view of the

end product based on very limited information. Certain details will change.

Preliminary Information: The product design is complete and final characterisation for volume production is in progress.

The datasheet represents the product as it is now understood but details may change.

No Annotation: The product has been approved for production and unless otherwise notified by Dynex any

product ordered will be supplied to the current version of the data sheet prevailing at the

time of our order acknowledgement.

All products and materials are sold and services provided subject to Dynex's conditions of sale, which are available on request.

Any brand names and product names used in this publication are trademarks, registered trademarks or trade names of their respective owners.

HEADQUARTERS OPERATIONS

DYNEX SEMICONDUCTOR LIMITED Doddington Road, Lincoln, Lincolnshire. LN6 3LF United Kingdom.

Phone: +44 (0) 1522 500500 Fax: +44 (0) 1522 500550 Web: http://www.dynexsemi.com

CUSTOMER SERVICE

Phone: +44 (0) 1522 502753 / 502901

e-mail: powersolutions@dynexsemi.com

© Dynex Semiconductor Ltd. Technical Documentation – Not for resale.

www.dynexsemi.com 10/10